



100V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
100V	14.5mΩ @ V _{GS} = 10V	53A
100 V	19.5mΩ @ V _{GS} = 6V	47A

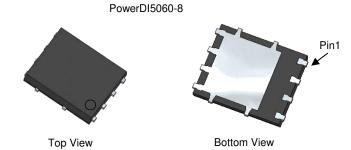
Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switch.

Applications

- Motor controls
- DC-DC converters
- Power managements

Site 1:



Site 2:



Top View **Bottom View**

PowerDI5060-8/SWP (Type UX)

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- Thermally Efficient Package—Cooler Running Applications
- High Conversion Efficiency
- Low RDS(ON)—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

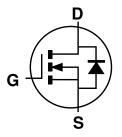
https://www.diodes.com/products/automotive/automotiveproducts/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

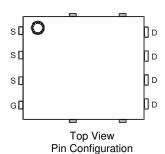
https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208@3
- Weight: 0.097 grams (Approximate)







D Пο SI ΠD sГ D GΠ

Top View Pin Configuration Internal Schematic

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. Notes:
 - 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes incorporated's definitions of Halogen- and Antimony-free, "Green" and
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



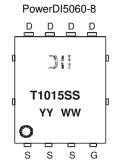
Ordering Information (Note 4)

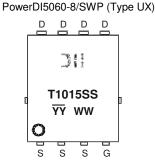
Part Number	Pankaga	Packing		
Pait Number	Package	Qty.	Carrier	
DMT10H015SPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMT10H015SPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





T1015SS = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	100	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 6) VGS = 10V	lD	53 43	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	120	Α
Maximum Continuous Body Diode Forward Current (Note 6)			ls	53	Α
Avalanche Current (Note 7), L = 3mH			las	7.5	Α
Avalanche Energy (Note 7), L = 3mH			Eas	85	mJ
Avalanche Current, L = 0.1mH			las	15.8	Α
Avalanche Energy, L = 0.1mH			Eas	12.5	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)		Rеја	55	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	78	W
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	1.6	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. Guaranteed by design. Not subject to product testing.



Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	VGS = 0V, ID = 1mA	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	11.3	14.5	mΩ	V _G S = 10V, I _D = 20A	
Static Drain-Source On-Resistance	RDS(ON)	_	14.7	19.5	11122	$V_{GS} = 6V, I_{D} = 20A$	
Diode Forward Voltage	V _{SD}	_	0.9	1.3	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	_	2343	_		V _{DS} = 50V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	487	_	pF		
Reverse Transfer Capacitance	Crss	_	26	_			
Gate Resistance	Rg	_	0.69	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	30.1	_		. 501/ 1 404	
Gate-Source Charge	Qgs	_	7.5	_	nC	$V_{DD} = 50V, I_D = 10A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Qgd	_	6.5	_			
Turn-On Delay Time	td(ON)	_	9.8	_			
Turn-On Rise Time	tr	_	7.8	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 10A, R_{g} = 6\Omega$	
Turn-Off Delay Time	tD(OFF)	_	22.5	_	ns		
Turn-Off Fall Time	t _F	_	9.6	_			
Reverse Recovery Time	trr	_	43.1	_	ns	I_ 10A di/dt 100A/	
Reverse Recovery Charge	Qrr	_	65.1	_	nC	$I_F = 10A$, di/dt = 100A/ μ s	

Notes:

^{7.} Guaranteed by design. Not subject to product testing. 8. Short duration pulse test used to minimize self-heating effect.





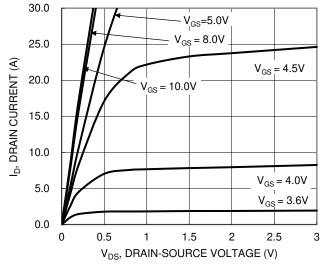


Figure 1. Typical Output Characteristic

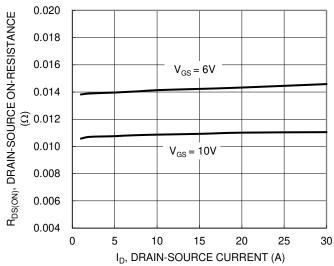


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

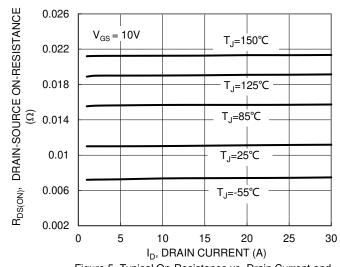


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

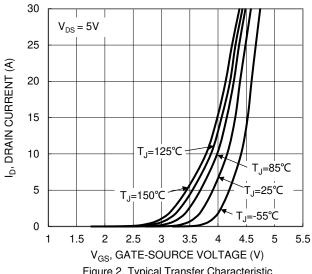


Figure 2. Typical Transfer Characteristic

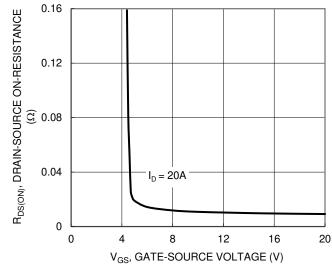


Figure 4. Typical Transfer Characteristic

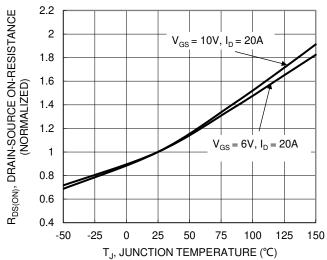


Figure 6. On-Resistance Variation with Temperature





30

25

20

15

10

5

0

0

0.3

I_S, SOURCE CURRENT (A)

 $V_{GS} = 0V$

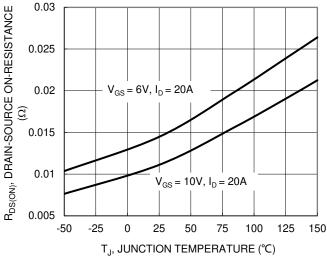
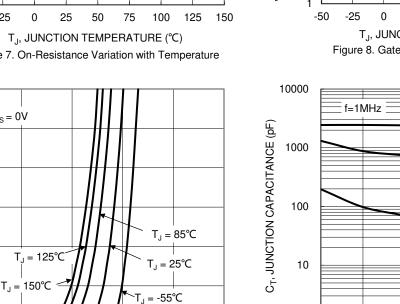


Figure 7. On-Resistance Variation with Temperature



1.5

V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

0.9

1.2

0.6

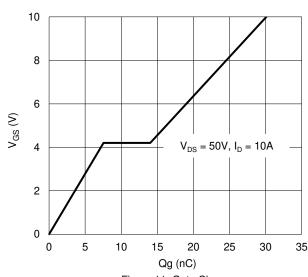


Figure 11. Gate Charge

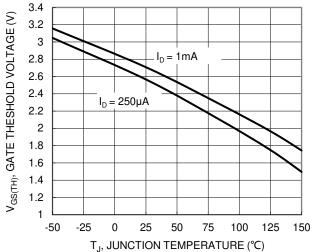


Figure 8. Gate Theshold Variation vs. Junction Temperature

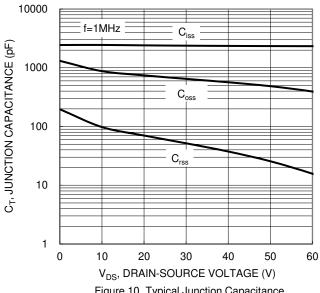
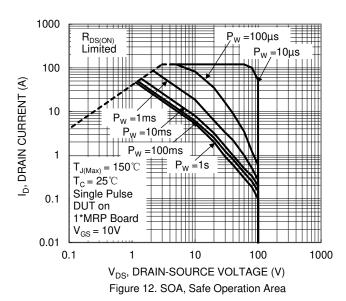


Figure 10. Typical Junction Capacitance



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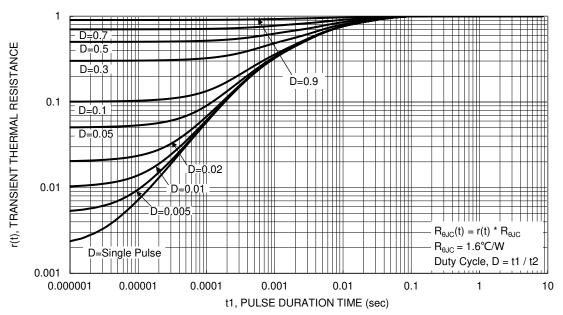


Figure 13. Transient Thermal Resistance

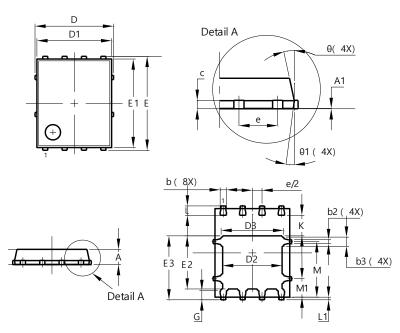


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

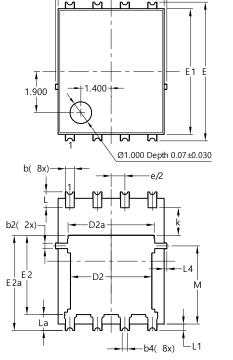
PowerDI5060-8



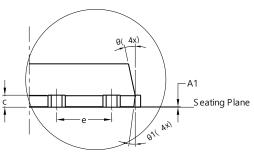
PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A 1	0.00	0.05			
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	Į	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Site 2:

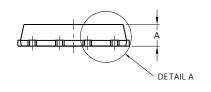
PowerDI5060-8/SWP (Type UX)



-D1



DETAIL A



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A 1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	0).25REF		
C D	0.230	0.330	0.277	
	5	.15 BS0		
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	\sim	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

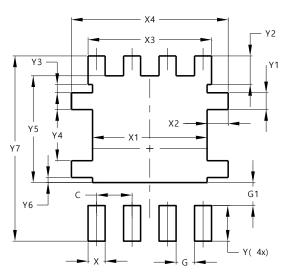


Suggested Pad Layout

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Site 1:

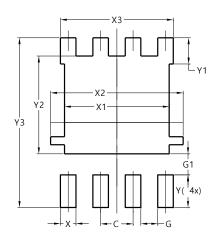
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value
Difficusions	(in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	5.190
Х3	4.420
Υ	1.270
Y 1	1.020
Y2	3.810
Y3	6.610



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